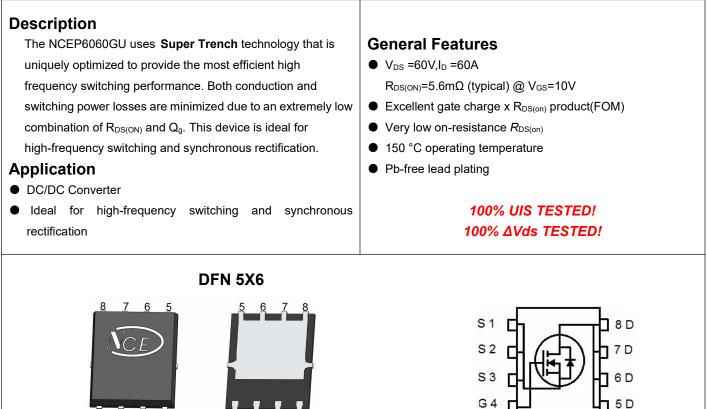
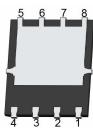


# NCE N-Channel Super Trench Power MOSFET



**Schematic Diagram** 





**Top View** 

**Bottom View** 

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P6060GU	NCEP6060GU	DFN5X6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous (Silicon Limited)	Ι <sub>D</sub>	60	A
Drain Current-Continuous(Tc=100°C)	I <sub>D</sub> (100℃)	42.4	Α
Pulsed Drain Current	I <sub>DM</sub>	170	A
Maximum Power Dissipation	PD	70	W
Derating factor		0.56	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	320	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C
Thermal Characteristic		·	·
Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	1.78	°C/W
Thermal Resistance, Junction-to-Ambient <sup>(Note 2)</sup>	R <sub>0JA</sub>	50	°C/W



## Electrical Characteristics (Tc=25 $^\circ\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	· · ·		•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	60		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =10V, $I_{D}$ =20A	-	5.6	7.0	mΩ
Forward Transconductance	<b>g</b> fs	$V_{DS}$ =5V,I <sub>D</sub> =20A	35	-	-	S
Dynamic Characteristics (Note4)	. I		·			
Input Capacitance	Clss	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V,	-	1700	-	PF
Output Capacitance	Coss		-	345	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	8	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =30V,I <sub>D</sub> =20A V <sub>GS</sub> =10V,R <sub>G</sub> =4.7Ω	-	8	-	nS
Turn-on Rise Time	tr		-	2	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	29	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	4	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =30V,I <sub>D</sub> =20A, V <sub>GS</sub> =10V	-	26.9		nC
Gate-Source Charge	Q <sub>gs</sub>		-	9.4		nC
Gate-Drain Charge	Q <sub>gd</sub>		-	4.6		nC
Drain-Source Diode Characteristics			· ·			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-		1.2	V
Diode Forward Current (Note 2)	ls		-	-	60	A
Reverse Recovery Time	trr	$T_J = 25^{\circ}C, I_F = I_S$	-	38		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	48		nC

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A$  =25° C. The the maximum allowed junction temperature of 150° C

3. Pulse Test: Pulse Width ≤ 300 $\mu$ s, Duty Cycle ≤ 2%.

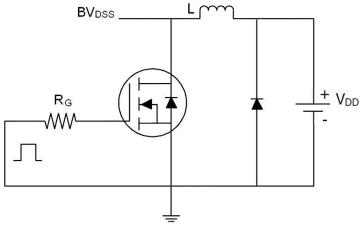
4. Guaranteed by design, not subject to production

5. EAS condition : Tj=25  $^\circ \rm C$  ,V\_DD=30V,V\_G=10V,L=0.5mH,Rg=25\Omega

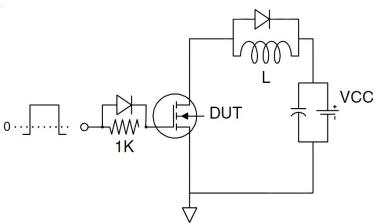


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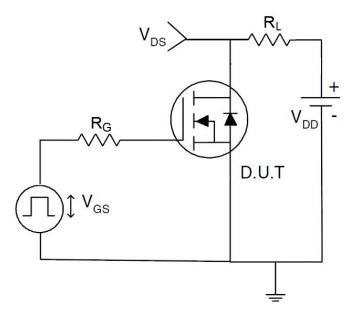
### Test Circuit 1) E<sub>AS</sub> test Circuit



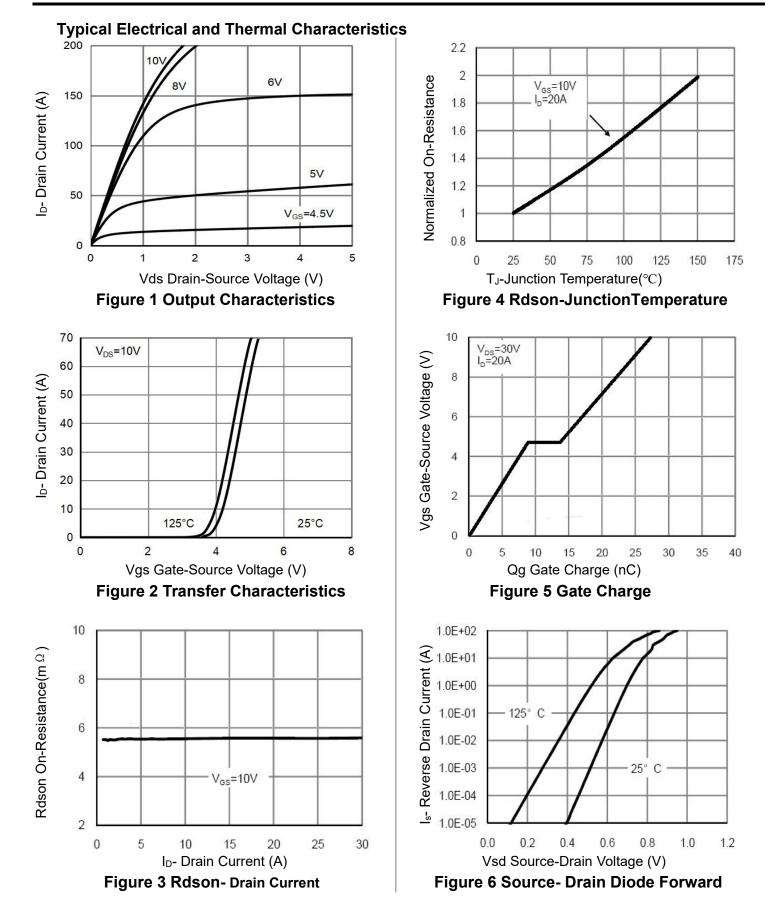
#### 2) Gate charge test Circuit



3) Switch Time Test Circuit



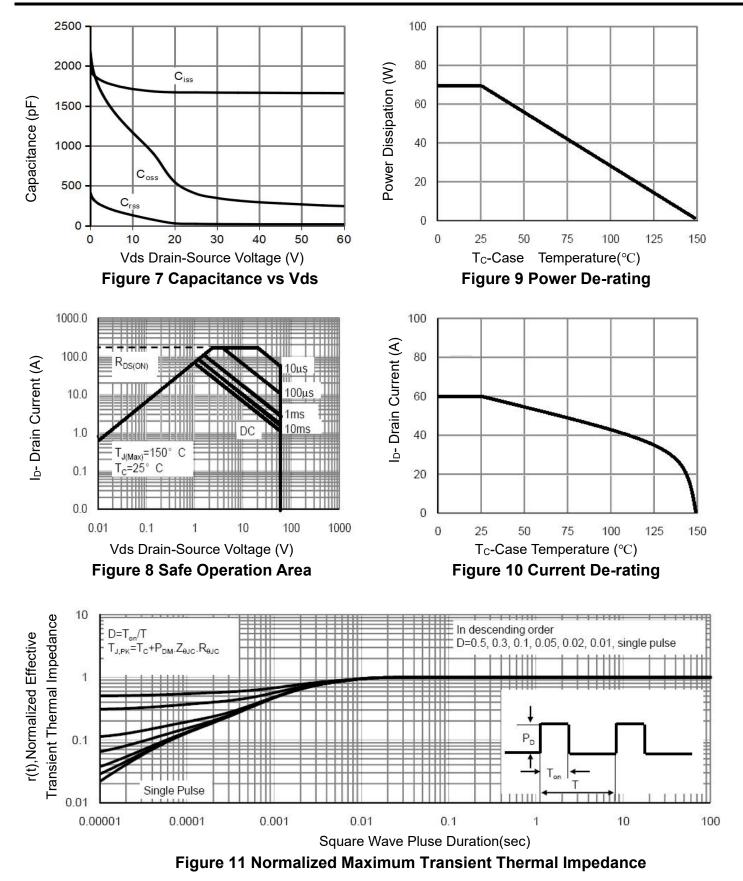






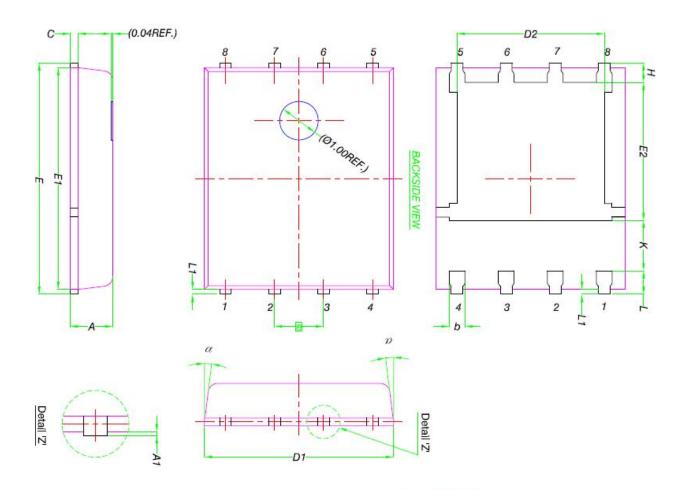
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# NCEP6060GU

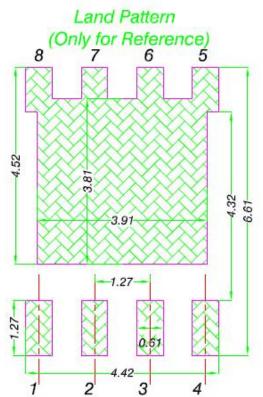




## DFN5X6-8L Package Information



-	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
A	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е		1.27 BSC	8	
Н	0.41	0.51	0.61	
К	1.10			
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	0°	-	12	





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